Electronic Acknowledgement Receipt

EFS ID:	1051582
Application Number:	10612764
Confirmation Number:	5896
Title of Invention:	Mold compound cap in a flip chip multi-matrix array package and process of making same
First Named Inventor:	Vassoudevane Lebonheur
Customer Number:	21186
Filer:	Joseph P. Mehrle/Anne Richards
Filer Authorized By:	Joseph P. Mehrle
Attorney Docket Number:	884.862US1
Receipt Date:	18-MAY-2006
Filing Date:	30-JUN-2003
Time Stamp:	18:43:28
Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		862responseSIGNED.pdf	166277	yes	17

Multipart Description		
Doc Desc	Start	End
Transmittal letter	1	1
Amendment - After Non-Final Rejection	2	2
Claims	3	10
Applicant Arguments/Remarks Made in an Amendment	11	17

Warnings:	
Information:	
Total Files Size (in bytes):	166277

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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.